🐺 Texas Instruments
---------------------

Bill of Materials TI DESIGNS TIDM-RM46XDRV8301KIT RM46 Control Card

ltem	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number	Alternate Part (Digikey)	PCB Footprint	Note
		C1,C2	40-5	0 10 5 50	AVX Corportation	04025U100FAT2A	478-5717-1-ND	0.400	
1			10pF 27pF	Cap: 10 pF 50v				0402	loading for oscillator
2	2	C101,C102	27pF 100pF	Cap: 27pF, > 5v	Yageo AVX Corportation	CC0402JRNP09BN270	311-1019-1-ND	0402	loading for oscillator
3	2	C26,C27		Cap: 100pF		04025A101FAT2A	478-3658-1-ND	0402	USB VCC 3.3 decoupling
4	4	C66, C69, C79-C80	10nF	Cap: 10nF,50v	TDK Corporation	C1005X7S2A103K050BB	445-5199-6-ND	0402	
5	42	C6-C11, C14-C22, C70-C78,C111- C122,C155-C160	0.1uF	Cap: 0.1uF, 50v	TDK Corporation	C1005X7R1H104M050BB	445-5933-1-ND	0402	decoupling
6		C28, C29	2.2uF	Cap: 2.2uF,>6v	TDK Corporation	C1608Y5V1C225Z	<u>445-3451-1-ND</u>	0603	
7	3	C131-C133	4.7uF	Cap: 4.7uF	Taiyo Yuden	JMK107BJ475MA-T	587-1255-1-ND	0603	decoupling
8	1	C45	10uF	Cap: 10uF, 50v	TDK Corporation	C3216X5R1H106K160AB	445-5998-6-ND	1206	
9	5	C42-C44, C141-C142	10uF	Cap: 10uF	Taiyo Yuden	JMK107BJ106MA-T	587-1256-1-ND	0603	VREG
10	2	C67,C68	22uF	Cap: 22uF 10v	Kemet	T491A226M010ZT	495-2207-1-ND	"A" 3216-18	Bulk capacitor
11	8	R2-R6, R8-R9, R101	0ohm	Res: 0	Vishay Dale	CRCW04020000Z0ED	541-0.0JCT-ND	0402	
12	31	R31-R34, R81-R100, R102, R111-R115, R117	50ohm	Res: 50	Panasonic Electronic Components	ERJ-2RKF49R9X	P49.9LCT-ND	0402	
13	3	R36, R105, R106	200ohm	Res:200	Vishav Dale	CRCW0402200RFKED	541-200LCT-ND	0402	
14	5	R26-R28, R50,R51	360ohm	Res:360	Panasonic Electronic Components	ERJ-2GEJ361X	P360JCT-ND	0402	
15	8	R13, R120-R123, R127, R138, R142	470ohm	Res:470	Panasonic Electronic Components	ERJ-2GEJ471X	P470JCT-ND	0402	
10	10		1Kohm	D 114				0.400	
16 17	16	R42-R44,R67,R128-R137, R139, R144	2.2Kohm	Res: 1K	Vishay Dale Vishay Dale	CRCW04021K00FKED	541-1.00KLCT-ND	0402	
17	12	R10-R12, R16-R17, R35, R37-R41, R141	2.2KONM	Res: 2.2K	Panasonic Electronic	CRCW04022K20FKED	541-2.20KLCT-ND	0402	
18	3	R45, R54,R55	4.87Kohm	Res: 4.87k	Components	ERJ-2RKF4871X	P4.87KLCT-ND	0402	
19	1	R20	40.2ohm	Res: 40.2	Panasonic Electronic Components	ERJ-2RKF40R2X	P40.2LDKR-ND	0402	
20	1	R21	80.6ohm	Res: 80.6	Panasonic Electronic Components	ERJ-2RKF80R6X	P80.6LDKR-ND	0402	
21	5	R150-R154	10Kohm	Res: 10K	Panasonic Electronic Components	ERJ-2RKF1002X	P10.0KLDKR-ND	0402	
22	1	R155	10Kohm	Res: 10K	Panasonic Electronic Components	ERJ-3EKF1002V	P10.0KHDKR-ND	0603	
23	1	R18	22Kohm	Res: 22K	Panasonic Electronic Components	ERJ-2RKF2202X	P22.0KLDKR-ND	0402	
24	1	R19	100Kohm	Res: 100K	Vishay Dale	CRCW0402100KFKED	541-100KLCT-ND	0402	
24	1	R24	105Kohm	Res: 105K	Panasonic Electronic Components	ERJ-2RKF1053X	P105KLDKR-ND	0402	
26	4	RN1-RN4	33ohm	Res Array: 33	Panasonic Electronic Components	EXB-28V330JX	Y7330CT-ND	0804	RES ARRAY 33 OHM
27	0	D47 D40	3301111	LED: Orange - SMT 0603	Lite-On Inc		160-1434-1-ND	0603 SMD	
28		D17, D18 D7		LED: Orange - SMT 0603 LED: White - SMT 0603	Panasonic Electronic	LTST-C190KFKT LNJ026X8BRA1	P13483CT-ND	0603 SMD	LED YELLOW ORANGE CLEAR LED WHITE HIGH BRIGHT USS 0603
29		D1		LED: Red - SMT 0603	Components Panasonic Electronic Components	LNJ212R8ARA	P11133CT-ND	0603	red LED
30	6	D8, D15, D102-D105		LED: Blue - SMT 0603	Panasonic Electronic Components	LNJ926W8CRA	P13484CT-ND	0603	LED BLUE HIGH BRIGHT USS 0603
31	1	D16		Diode	On Semiconductor	MBRS340T3G	MBRS340T3GOSDKR-ND	SMC	DIODE SCHOTTKY 40V 4A
32		L3, L101-L102		Ferrite	Laird-Signal Integrity Products	HZ0805E601R-10	240-2399-1-ND	0805 SMD	FERRITE 500MA 600 OHM
32	3	L3, L101-L102		Inductor: 33uH	Epcos (TDK)	B82464G4333M	495-1803-1-ND	SMD	FIXED IND 33UH 1.85A 75 MOHM
34	1	L4 J101		USB-B-mini-smt	Hirose Electric Co Ltd	UX60-MB-5ST	H2959CT-ND	USB_MINIB_REC	CONN RECEPT MINI USB2.0 5POS
35		JP1		Power Jack	CUI Inc	PJ-006A-SMT-TR	CP-006APJDKR-ND	SMD	CONNINCECEPT MINI USB2.0 SPOS
35	1	JP1 P5		RJ45 Jack	Pulse Electronics Corportation	J0011D21BNL	553-1485-ND	rj45-pulse J0	CONN MAGJACK 1PORT 100 BASE-TX
37		P5 Q1		Power MOS FET	Fairchild Semiconductor	FDD8778	FDD8778TR-ND	D-Pak, TO-252-3	MOSFET N-CH 25V 35A
38	2	S1-S3		Switch: PB / SM	C&K Components	PTS635SL25SMTR LFS	CKN9119CT-ND	D T an, 10-202-0	Reset, SWITCH TACTILE SPST-NO 0.05A 12V
38	3	S1-53 SW1		Switch: PB / SM Switch: 8POS	C&K Components	TDA08H0SB1R	CKN9504DKR-ND	1	SWITCH DIP 8POS HALF PITCH 24V
40	1	T101		IC:IRLML6302	International Rectifier	IRLML6302GTRPBF	IRLML6302GTRPBFDKR-ND	SOT-23-3	MOSFET P-CH 20V 0.78A
40 41	1			IC:RM46-337	Texas Instruments	RM46L852ZWTT	INLIVILOOUZG I KEDEDAR-ND	NFBGA-337	NOGILI F-0020V 0.70A
41	4	U2-U5		IC: TPD4E002	Texas Instruments	TPD4E002DRLR	296-21694-1-ND	SOT-553	ic, transient voltage suppressor diode 3VWM
42	4	U2-U5 U6-U8		IC: 1PD4E002 IC: SN74CBTLV3257	Texas Instruments	SN74CBTLV3257PWR	296-21694-1-ND 296-9138-1-ND	TSSOP16	IC LV FET MUX/DEMUX
43	3	U12		IC: SN/4CB1LV3257 IC: DP83640	Texas Instruments	DP83640TVV	296-9138-1-ND DP83640TVV-ND	48LQFP	
44	1	012		IG. DF03040	I CARS INSTITUTIENTS	DF030401VV	DF030401VV-IND	HOLUFY	TXRX PHY IEEE 1PORT 1588

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number	Alternate Part (Digikey)	PCB Footprint	Note
45	1	U101		IC: FT2232H	FTDI, Future Technology Devices International Ltd	FT2232HL-REEL	768-1024-1-ND	QUAD.50M/64-LQFP	IC USB HS DUAL UART/FIFO
46	1	U102		IC: 93LC56	Microchip Technology	93LC56C-I/SN	93LC56C-I/SN-ND	SOIC8	IC EEPROM 2KBIT 3MHZ
47	1	U103		IC: TPD2E001	Texas Instruments	TPD2E001DRLR	296-21883-6-ND	SOT-5	TVS DIODE 5.5VWM 100VC
48	1	U104		IC: TPS73033	Texas Instruments	TPS73033DBVR	296-17580-6-ND	SOT-23-5	IC REG LDO 3.3V 0.2A
49	1	U109		IC: XC2C32A_VQ44	Xilinx Inc	XC2C32A-6VQG44C	122-1404-ND	44VQFP	IC CPLD 32MC 5.5NS
50	1	U118		IC:SN74AHC1G14	Texas Instruments	SN74AHC1G14DBVR	296-1092-6-ND	SOT-23-5	IC SCHMITT-TRG INV GATE
51	1	U119		IC: TLV810SDBZR	Texas Instruments	TLV810SDBZR	296-29200-1-ND	SOT-23-3	IC VOLT SUPERVISR 2.93V
52	1	U121		IC:SN74LVC125APWR	Texas Instruments	SN74LVC125APWR	296-1222-6-ND	14-TSSOP	IC BUS BUFF TRI-ST QD
53	3	U115,U116,U117		IC:ISO7240MDW	Texas Instruments	ISO7240MDW	296-22629-5-ND	16 SOIC	DGTL ISO 2.5KV GEN PURP
54	1	U122		IC: TL7700CPW	Texas Instruments	TL7700CPWR	296-13050-6-ND	8-TSSOP	IC SUPPLY VOLT SUPERVISOR
55	1	VR1		IC:TPS65381	Texas Instruments	TPS65381-Q1		32-HTSSOP	VREG
56	1	Y3	16MHz	16MHz Crystal	ECS Inc	ECS-160-20-23A-EN-TR	XC982CT-ND	2-SMD	Crystal 16.0000MHz 30ppm 20pF 60 Ohm -40°C - 85°C
57	1	Y5	50MHz	50MHz Oscillator	Abracon LLC	ASV-50.000MHZ-EJ-T	535-9330-1-ND	SMD	OSC XO 50.000MHZ HCMOS
58	1	Y101	12MHz	12MHz CRYSTAL	ECS Inc	XC1118CT-ND	XC1118CT-ND	2-SMD	Crystal 12.0000MHz 30ppm 20pF 80 Ohm -20°C - 70°C
NO POP	16	C46-C57, C60-C63							NO POP
NO POP	2	R14,R15	0ohm	Res: 0				0402	NO POP
NO POP	3	R103,R104,R107	0ohm	Res: 0				0402	NO POP
NO POP	1	R140	200ohm	Res: 200				0402	NO POP
NO POP	1	J102		Header: 2x1 .100					NO POP
NO POP	3	R124-R126	1Kohm	Res: 1k					NO POP
NO POP	1	R23	470ohm	Res: 470				0402	NO POP
NO POP	9	TP1, P8, P11-P17		TEST Point					NO POP
NO POP	1	P4		DIMM-100					NO POP
NO POP	1	R22	0ohm	Res: 0	Yageo	RC0805JR-070RL	311-0.0ARCT-ND	0805	NO POP
NO POP	1	S4		Switch: PB / SM	C&K Components	PTS635SL25SMTR LFS	CKN9119CT-ND		SWITCH TACTILE SPST-NO 0.05A 12V

## **IMPORTANT NOTICE FOR TI REFERENCE DESIGNS**

Texas Instruments Incorporated ("TI") reference designs are solely intended to assist designers ("Buyers") who are developing systems that incorporate TI semiconductor products (also referred to herein as "components"). Buyer understands and agrees that Buyer remains responsible for using its independent analysis, evaluation and judgment in designing Buyer's systems and products.

TI reference designs have been created using standard laboratory conditions and engineering practices. **TI has not conducted any testing other than that specifically described in the published documentation for a particular reference design.** TI may make corrections, enhancements, improvements and other changes to its reference designs.

Buyers are authorized to use TI reference designs with the TI component(s) identified in each particular reference design and to modify the reference design in the development of their end products. HOWEVER, NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY THIRD PARTY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT, IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of TI.

TI REFERENCE DESIGNS ARE PROVIDED "AS IS". TI MAKES NO WARRANTIES OR REPRESENTATIONS WITH REGARD TO THE REFERENCE DESIGNS OR USE OF THE REFERENCE DESIGNS, EXPRESS, IMPLIED OR STATUTORY, INCLUDING ACCURACY OR COMPLETENESS. TI DISCLAIMS ANY WARRANTY OF TITLE AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, QUIET ENJOYMENT, QUIET POSSESSION, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS WITH REGARD TO TI REFERENCE DESIGNS OR USE THEREOF. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY BUYERS AGAINST ANY THIRD PARTY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON A COMBINATION OF COMPONENTS PROVIDED IN A TI REFERENCE DESIGN. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, SPECIAL, INCIDENTAL, CONSEQUENTIAL OR INDIRECT DAMAGES, HOWEVER CAUSED, ON ANY THEORY OF LIABILITY AND WHETHER OR NOT TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES, ARISING IN ANY WAY OUT OF TI REFERENCE DESIGNS OR BUYER'S USE OF TI REFERENCE DESIGNS.

TI reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques for TI components are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

Reproduction of significant portions of TI information in TI data books, data sheets or reference designs is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards that anticipate dangerous failures, monitor failures and their consequences, lessen the likelihood of dangerous failures and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in Buyer's safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed an agreement specifically governing such use.

Only those TI components that TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components that have **not** been so designated is solely at Buyer's risk, and Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2015, Texas Instruments Incorporated